



Docket No.: M4065.0127/P127-A  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Kie Y. Ahn, et al.

Application No.: 09/660,324

Group Art Unit: 2823

Filed: September 12, 2000

Examiner: E. Toledo

For: SILICON MULTI-CHIP MODULE  
PACKAGING WITH INTEGRATED  
PASSIVE COMPONENTS AND METHOD  
OF MAKING

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**STATEMENT OF COMMON OWNERSHIP**

Commissioner for Patents  
Washington, DC 20231

Dear Sir:

The present Application, numbered 09/660,324, and U.S. Patent No. 6,201,287 B1 (Forbes) describe and claim subject matter which, at the time the invention of Application 09/660,324 was made, was commonly owned by Micron Technology Inc., Boise ID.

Dated: October 26, 2001

Respectfully submitted,

By   
Thomas J. D'Amico

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2823  
PTO/SB/21 (08-00)

Approved for use through 10/31/2002. OMB 0651-0031  
U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

## TRANSMITTAL FORM

(to be used for all correspondence after initial filing)

		Application Number	09/660,324
		Filing Date	September 12, 2000
		First Named Inventor	Kie Y. Ahn
		Group Art Unit	2823
		Examiner Name	F. Toledo
Total Number of Pages in This Submission		Attorney Docket Number	
		M4065.0127/P127-A	

### ENCLOSURES (check all that apply)

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<input checked="" type="checkbox"/> Amendment/Reply	<input type="checkbox"/> Licensing-related Papers	<input type="checkbox"/> Appeal Communication to Group (Appeal Notice, Brief, Reply Brief)
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<input type="checkbox"/> Affidavits/declaration(s)	<input type="checkbox"/> Petition to Convert to a Provisional Application	<input type="checkbox"/> Status Letter
<input type="checkbox"/> Extension of Time Request	<input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address	<input type="checkbox"/> Other Enclosure(s) (please identify below)
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<input type="checkbox"/> Response to Missing Parts/ Incomplete Application	Remarks	
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### SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT

Firm or Individual Name	DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP Thomas J. D'Amico
Signature	
Date	October 26, 2001

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